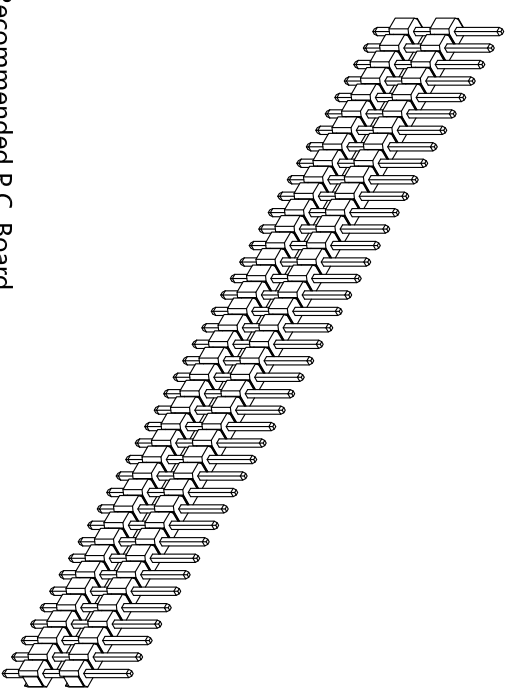
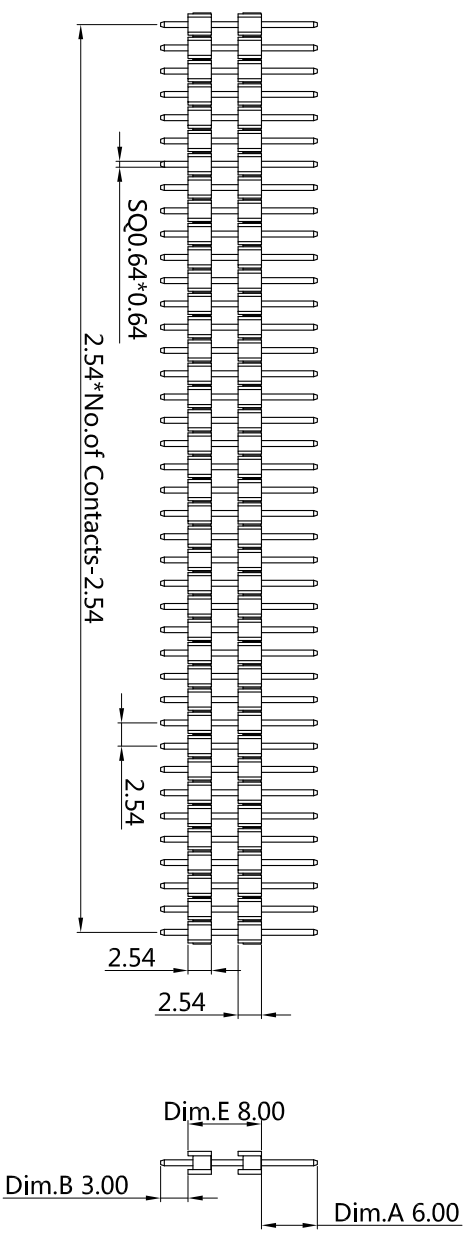
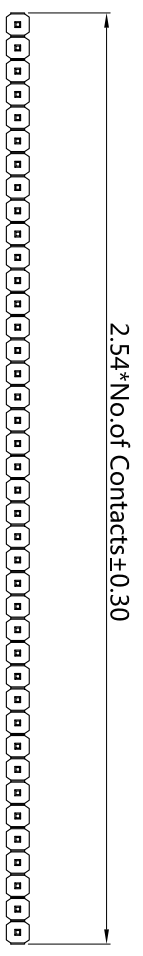
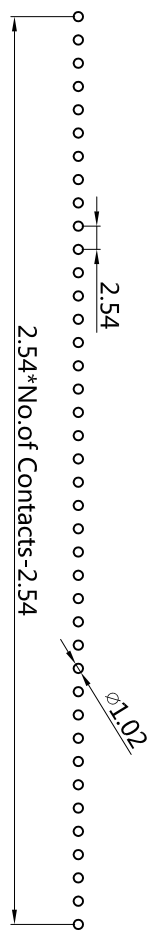


1	2	3	4	5	6	7	8
					Current Rating: 3 Amps Insulator Resistance: 1000 Megohms min Dielectric Withstanding: AC 500V Contact Resistance: 20mΩ MAX Operation Temperature: -40~+105°C Max processing temp: 230°C for 60seconds Max processing temp: 260°C for 10seconds Contact Material: Brass Insulator material: Standard: Polyester, UL 94V-0 Standard: PA6T		



Recommended P.C. Board
SMD Layout



(RoHS Compliant) H1 X 25 - 1 XX S0 BK X D00 X

1. Insulator material: 5. Contact Plated: 6.Special Options

- A=PBT N=PA6T T=Matte Tin over Nickel I=Gold 1μ" J=Gold 10μ" K=Matte Tin 100μ"
- L=LCP P=PA9T W=Matte Tin over nickel 150μ" E=Gold 5μ" G=Gold 10μ" M=Gold 15μ" N=Matte Tin 100μ"
- Y=Bright Tin over Nickel F=Gold Flash, Matte Tin 100μ" J=Gold 10μ" , Matte Tin 100μ"
- 3. Tail Style: A=Gold 3μ" L=Gold 15μ" U=Gold 30μ" V=Gold 30μ" Matte Tin 100μ"
- 4. Color: S0=180° B=Gold 3μ" , Matte Tin 100μ" M=Gold 15μ" , Matte Tin 100μ"
- BK=Black D=Gold 5μ" V=Gold 30μ" Matte Tin 100μ"

7. Packing: A=Bag B=Tube C=Tray E=Cap+Reel

		东莞市震升电子有限公司 DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD	
BOM 1:	H1N25-140BKHC1	PART NO.	H1X25-1XXS0BKXD00X
BOM 2:	SQ0.64-17.1-X-C12	DRAWING NO	ZS-00151-P
BOM 3:		DRAWN BY	Deng jin Quan
		APPROVAL BY	Chen xiao guang
TEL:0769-85305015 FAX:0769-85845060		EDITION:A1	2021-12-26
		SCALE:1:1	2021-12-28
		UNIT:M.M	